

Guideline of Sponsorship at the 35th Annual Sensor Symposium

Since 1981, SENSOR SYMPOSIUM has been the leading conference for the researchers in sensors, MEMS and their application systems in Japan. Today the symposium became the major annual event for the Institute of Electrical Engineers of Japan (IEEJ) Sensors and Micromachines Society.

The 35th SENSOR SYMPOSIUM will be held from October 30 through November 1, 2018 in Sapporo, Japan. Three cooperative symposia will be held in the same venue at the same time; (1) the 9th Symposium on Micro-Nano Engineering organized by The Japan Society of Mechanical Engineers, (2) the 10th Symposium on Integrated MEMS Technology organized by The Japan Society of Applied Physics, and (3) the 38th Workshop organized by Society for Chemistry and Micro-Nano Systems.

The 35th SENSOR SYMPOSIUM offers an opportunity to be a bridge between R&D and commercial market through exhibition and sponsorship.

Conference Name:

The 35th Sensor Symposium on Sensors, Micromachines and Applied Systems

Date: October 30- November 1, 2018

Venue: Sapporo Community Plaza

<http://www.sapporo-community-plaza.jp/access.html>

Cooperated with:

The Japan Society of Mechanical Engineers

The Study Group of the Integrated MEMS, The Japan Society of Applied Physics

The Society for Chemistry and Micro-Nano Systems

Conference Website: http://www.sensorsymposium.org/index_e.html

Supported by (on request)

Japan Institute of Electronics Packaging

The Japan Society of Applied Physics

The Society of Instrument and Control Engineers

The Institute of Systems, Control and Information Engineers

Japan Society of Next Generation Sensor Technology

The Japan Society for Precision Engineering

The Japan Society of Mechanical Engineer, Micro-Nano Science & Technology Division

The Society of Sensing Technology of Japan

The Electrochemical Society of Japan

The Institute of Electronics, Information and Communication Engineers

The Japan Society of Mechanical Engineers

The Japan Society of Vacuum and Surface Science

The Society of Materials Science, Japan

Reliability Engineering Association of Japan

Japanese Society for Medical and Biological Engineering

The Japan Society of Infrared Science and Technology

The Robotics Society of Japan

New Ceramics Forum

Micromachine Center

Laser Society of Japan

Technical Committees of IEEJ Sensors and Micromachine Society

Registration fee:

	Early Bird fee before October 13, 2018	Regular and onsite fee after October 14, 2018
Student (Member*)	¥ 5,000	¥ 8,000
Student (Non-member)	¥13,000	¥ 18,000
Non-student (Member*)	¥22,000	¥30,000
Non-student (Non-member*)	¥45,000	¥55,000

*Members of sponsors or supported organizations

Sponsorship & Benefit

Sponsorship type	Description	Sponsorship Fee
Regular Sponsorship		108,000 JP Yen 8% tax included
Lanyards Sponsorship	Company name will be printed in the lanyards for the conference. Maximum: 2 affiliations to be applied.	162,000 JP Yen 8% tax included
Sponsorship benefit	Description	
Sponsor benefit	One free ticket of 3-day symposium For additional participants, the following discounted fee will be applied for sponsors: 21,600 JP Yen per person	
	Company logo will be uploaded at the symposium website	
	Company logo will be included in the handout of the program which will be distributed to all participants for the symposium.	
	Advertising space will be offered in the handout of the program which will be distributed to all participants for the symposium at additional advertising fee of 54,000 JP Yen.	

Half-page (A5 wide size) advertisement in the conference handout is available only for exhibitors with additional 54,000 yen

The conference handout will be distributed among all participants of the conference.

Size: Trim Size 120mm depth x180mm wide

File types:

Print ready PDFs should be made in CMYK (cyan, magenta, yellow and black) using PDFx1a profile. The PDFx1a profile can be found when exporting to PDF or when distilling a Postscript file using Acrobat Distiller.

The PDFx1a profile contains a series of well defined subsets that protects the integrity of the fonts and colors contained therein.

* Fonts will be properly embedded into the file

* All color data must be greyscale, CMYK or named spot colors.

* The file cannot contain RGB, LAB data.

* Encryption cannot be used.

EPS files from Illustrator are acceptable CS2-CS5 (Creative Suite 5), with text save to outlines/paths or supply all fonts and hi-resolution Photoshop files (300dpi) usually saved in JPG, TIFF, PSD or EPS formats.

While our production department will do everything they can to ensure that your advertising is processed as error-free as possible, we cannot take responsibility for the color reproduction of any

PDFs containing RGB pictures and logos.

Application

Fill in the sponsorship application form and send it to the secretariat by email.

Sensorsympo_2018@semiconportal.com

Application Due

October 1, 2018

Payment

Both credit card payment and bank transfer payment is available.

Please note that the remittance charge should be covered by sender.

Cancellation Policy

No cancellation is to be charged until October 1, 2018. After the date, 100% cancellation charge will be applied.

Contact

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http://www.sensorsymposium.org/index_e.html